

UM10973

LPCXpresso54114

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User manual

Document information

Info	Content
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Abstract	LPCXpresso54114 User Manual



Revision history

Rev	Date	Description
1.1	20160225	Applied the updated user manual template.
1.0	20160218	Initial version.

Contact information

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1. Introduction

The LPCXpresso™ family of boards provides a powerful and flexible development system for NXP's Cortex®-M family of MCUs. They can be used with a wide range of development tools, including the NXP's LPCXpresso IDE. The LPCXpresso54114 board has been developed by NXP to enable evaluation of and prototyping with the LPC54110 family of MCUs, and is based on the LPC54114J256BD64 version of the MCU.

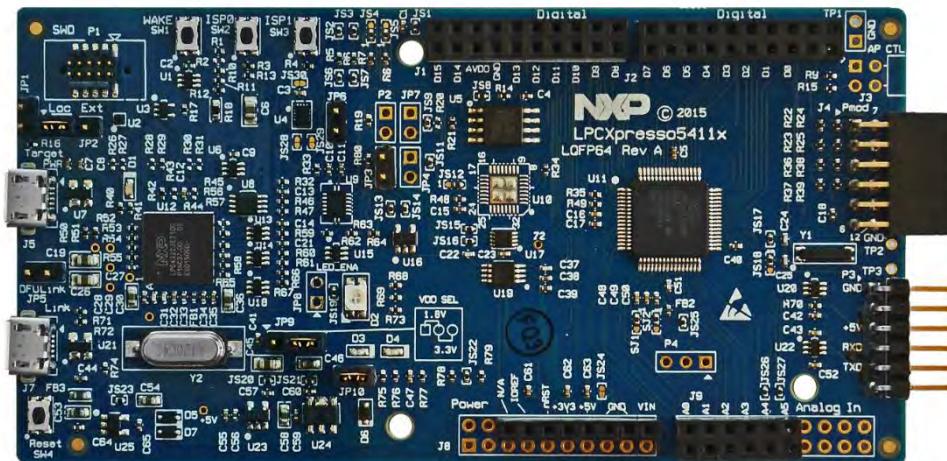


Fig 1. LPCXpresso54114 Board

This document describes the LPC54114 LPCXpresso LQFP board hardware. The following aspects of interfacing to the board are covered by this guide:

- Main board features.
 - Setup for use with development tools.
 - Supporting software drivers.
 - Board interface connector pin out.
 - Jumper settings.

2. Feature summary

The LPCXpresso54114 board includes the following features:

- On-board, high-speed USB based, Link2 debug probe with ARM's CMSIS-DAP and SEGGER J-Link protocol options.
- Link2 probe can be used with on-board LPC54114 or external target.
- Support for external debug probes.
- Tri-color LED.
- Target Reset, ISP, and WAKE buttons.
- Expansion options based on Arduino UNO and PMod™, plus additional expansion port pins.
- On-board 1.8/3.3V or external power supply options.
- Built-in power consumption measurement.
- UART, I²C and SPI port bridging from LPC54114 target to USB via the on-board debug probe.
- 8Mb Macronix MX25R SPI flash.
- FTDI UART connector.

2.1 Board layout and settings

This section provides a quick reference guide to the main board components, configurable items, visual indicators and expansion connectors. The layout of the components on the LPCXpresso54114 board is shown in [Fig 2](#).

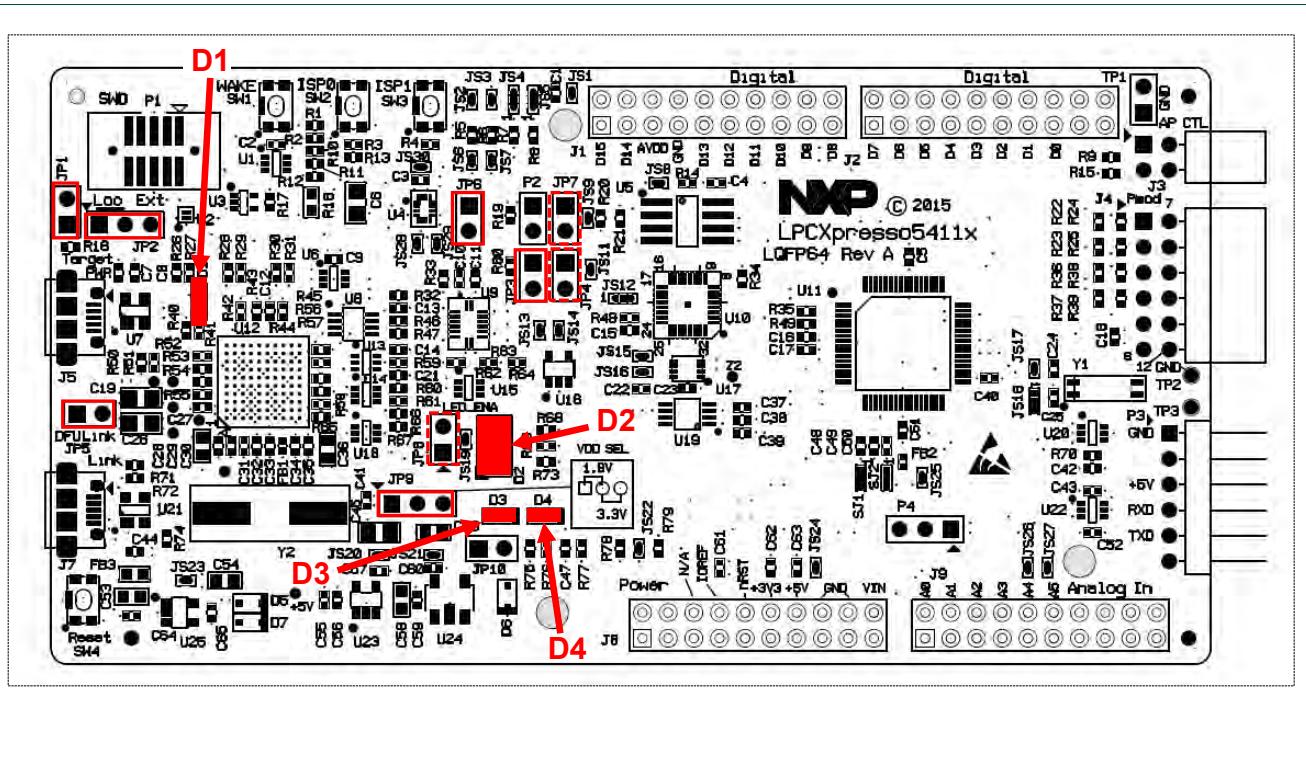


Fig 2. LPCXpresso54114 layout

The function of each identified component is listed in [Table 1](#).

Table 1. Table Board interface components

Circuit ref	Description	Ref section
D1	Link2 LPC43xx BOOT0_LED indicator. Reflects the state of LPC43xx Link2 MCU P1_1. When the boot process fails, D1 will toggle at a 1 Hz rate for 60 seconds. After 60 seconds, the LPC43xx is reset.	0
D2	Tri-color LED driven by Target LPC54114 MCU. JP8 must be shunted for +3.3V to be applied to D2 anode. The default shunt for JP8 is a 0Ω resistor installed at JS19.	0
D3	Target LPC54114 Power LED.	0
D4	Target LPC54114 Reset LED – LED is on anytime the Target RESETn is pulled low.	0
J1, J2, J8, J9	Expansion connectors, including Arduino Uno rev3 compatible connectivity.	8
J3	External processor control header. This connector provides access to the LPC54114 control and ISP0 boot control to enable an external device control reset and entry into I2C/SPI boot mode.	n/a
J4	PMod™ (SPI / I ² C) Bridge connector. An external Application Processor (AP) or PMod™ peripheral may be connected to the LPC54114 Target MCU SPI and I2C via this connector.	8

Circuit ref	Description	Ref section
J5	Target MCU Power / USB Device connector. Connect this micro USB B-type connector to a +5V power source when it is desired to power only the Target MCU, and leave the on-board Link2 debug probe unpowered.	n/a
J6	Link2 micro USB B-type connector. Powers both the Link2 side of the board and LPC54114 Target side of the board. Power the board from this connector when using the on-board debug probe to debug the LPC54114 Target MCU.	Table 2
JP1	LPC54114 Target SWD disable – 2-position jumper pins. 1) Jumper open (default) the LPC54114 Target SWD interface enabled. Normal operating mode where the Target SWD is connected to either the on-board Link2 debug probe or an external debug probe. Jumper shunted, the LPC54114 Target SWD interface is disabled. Use this setting only when the on-board Link2 debug probe is used to debug an off-board Target MCU.	6
JP3	JP3 can be installed to reduce the voltage sense resistance (used by the on-board current measurement circuitry) from 8.24 ohms to 4.12 ohms.	5.1
JP4	A current meter may be installed across JP4 terminals to measure the LPC54114 current consumption. By default JP4 is shunted by a 0Ω resistor installed at JS11; remove this shunt to measure current at JP4.	5.1.2
JP5	Link2 (LPC43xx) force DFU boot – 2 position jumper pins. 1) Jumper open (default) for Link2 to follow the normal boot sequence. The Link2 will boot from internal flash if image is found there. With the internal flash erased the Link2 normal boot sequence will fall through to DFU boot. Jumper shunted to force the Link2 to DFU boot mode. Use this setting to reprogram the Link2 internal flash with a new image or to use the LPCXpresso IDE with CMSIS-DAP protocol.	6.1.3
JP6	JP6 is used to isolate the Link2 debug probe (SPI bridge function) from the LPC54114 target to prevent leakage current in power critical applications / current consumption analysis. JP6 needs to be fitted to use the SPI bridging function between the LPC54114 and Link2. This jumper is not fitted by default.	n/a
JP7	On-board reset enable/disable. This jumper (not factory installed) connects the reset button and reset signal from the expansion connector J1 to the LPC54114 reset input. This jumper is shunted by a zero ohm resistor on SJ9. This jumper is intended to be used when an external host processor (controlling reset) is connected at J3.	n/a
JP8	Tri-color LED anode voltage enable: 1) By default JP8 is shunted by a 0Ω resistor installed at JS19. To disable +3.3V to the tri-color led common anode, remove the 0Ω resistor installed at JS19.	5.1 and 0
JP9	Power supply voltage selection – 3 position jumper pins. 1) Jumper 1–2: LPC54114 is powered at 1.8V. Jumper 2–3 (default): LPC54114 is powered at 3.3V.	n/a
JP10	Target connector USB (J5) VBUS to LPC54114 connection: 1) Installed (default): JP10 connects VBUS from Target USB connector to the LPC54114. Not installed: VBUS from J5 is unconnected.	n/a

Circuit ref	Description	Ref section																				
P1	10-pin SWD connector – The SWD connector is used to debug the LPC54114 Target from an external debug probe. The same SWD connector can also be used to connect the on-board Link2 debug probe to an off-board target MCU (for this JP1 must be shunted).	6																				
P2	LPC54114 VDD current monitor Vsense measurement. The Vsense can be measured with a volt meter. Pin 1 (square pad) is positive and pin 2 is negative. LPC54114 current is calculated by dividing the measured voltage at P2 by the Vsense resistance value of 4.12Ω .	5.1.1																				
P3	FTDI serial header. In addition to provide a serial output from LPC54114, the Target side of the board can be powered from the FTDI header. The LPC54114 supports serial ISP boot from the FTDI header.	4.1																				
P4	External ADC reference input. The pads of this header enable external VREF (negative and positive) ADC reference voltages to be injected. Pin 1 (indicated by the square pad) of the connector footprint can connected to the VREFP pin of the LPC54114 by removing the zero ohm resistor at SJ2 from position 1-2 and bridging pads 2-3 instead. Similarly, Pin 3 of P4 can be connected to the VREFN of the LPC54114 by removing the zero ohm resistor at SJ1 from position 1-2 and bridging pads 2-3 instead.	LPC54110 User Manual																				
SW1	LPC54114 Target WAKE pushbutton. When pressed the WAKE switch will drive LPC54114 P0_24 to a low level.	9.3																				
SW2, SW3	These switches can be used to force the LPC54114 in to ISP boot modes: <table border="1"> <tr> <th>Boot mode</th> <th>ISP0</th> <th>ISP1</th> <th>Vbus (from J5)</th> </tr> <tr> <td>I2C/SPI boot</td> <td>Pressed</td> <td>Pressed</td> <td>X</td> </tr> <tr> <td>UART boot</td> <td>Pressed</td> <td></td> <td>0</td> </tr> <tr> <td>USB Mass storage</td> <td>Pressed</td> <td></td> <td>1</td> </tr> <tr> <td>Boot from internal flash</td> <td></td> <td></td> <td></td> </tr> </table> After reset these pins may also be used to generate interrupts.	Boot mode	ISP0	ISP1	Vbus (from J5)	I2C/SPI boot	Pressed	Pressed	X	UART boot	Pressed		0	USB Mass storage	Pressed		1	Boot from internal flash				9.2
Boot mode	ISP0	ISP1	Vbus (from J5)																			
I2C/SPI boot	Pressed	Pressed	X																			
UART boot	Pressed		0																			
USB Mass storage	Pressed		1																			
Boot from internal flash																						
SW4	LPC54114 Target Reset pushbutton.	9.1																				
TP1	Ground terminal test point.	n/a																				
U12	Link2 MCU	n/a																				
U11	LPC54114 Target LQFP64 MCU	n/a																				

3. Getting Started

By default, the LPCXpresso54114 is configured to use the on-board debug probe (Link2) to debug the on-board target (LPC54114), using the CMSIS-DAP debug protocol pre-programmed into the Link2 Flash memory. The LPCXpresso IDE (available for free download at <http://www.nxp.com/lpcxpressoide>) or development tools that support the CMSIS-DAP protocol can be used in the default configuration. Check with your toolchain vendor for availability of specific device support packs for the LPC54110 family of devices.

Note that when using the LPCXpresso IDE, the on-board Link2 can also be booted in DFU mode by installing a jumper on JP5; if this is done then the IDE will download CMSIS-DAP to the probe as needed. Using DFU boot mode will ensure that the most up-to-date / **compatible** firmware image is used with the IDE. Note that spare jumpers are provided in the board packaging, taped to the card insert beneath the board.

Installation steps for use with LPCXpresso IDE on a Windows 7/8/10 platform (booting Link2 in DFU mode):

1. Download and install the LPCXpresso IDE (version 8.1 or later).
2. Install JP5 to force the Link2 debug probe to boot in DFU mode (see notes above).
3. Connect the LPCXpresso54114 board to the USB port of your host computer, connecting a micro USB cable to connector J7 ("Link"). The board will boot a simple LED blinky example using the tricolor LED, alternating between red and green.
4. Allow about 10 seconds for the LPCXpresso54114 devices to enumerate for the first time; the device will appear as "LPC Device".
5. Download the LPCOpen examples & drivers from <https://www.nxp.com/lpcopen> or <https://www.nxp.com/OM13089>, selecting the version for the toolchain you are using; project files for LPCXpresso IDE, Keil and IAR tools are available.
6. Start the LPCXpresso IDE and import the LPCOpen zip file by clicking Import project(s) in the "Start here" panel."
7. The simplest example is periph_blinky, which will blink the tricolor LED (fast blinking of the red LED) on the LPCXpresso54114. Click on the periph_blinky in the "Project Explorer" panel, then click Debug 'periph_blinky' in the "Start here" panel. This will build the project and then launch the debug session.
8. After detecting and booting the Link2, the IDE will prompt for selection of the processor core to debug – M4 or M0. Select the M4 target. Note that after this selection has been made once for a given project, the IDE will assume this as the default for that project.
9. The IDE will show a source code window and break at the function main(). Press F8 (or use the Resume icon) to run the program.

Installation steps for use with third party tools on a Windows 7/8/10 platform (Link2 configured for CMSIS-DAP):

1. Download and install LPCScript or the Windows drivers for LPCXpresso boards (<http://www.nxp.com/lpcutilities>). This will install required drivers for the board.
2. Ensure JP5 is open to force the Link2 debug probe to boot from internal flash.

3. Connect the LPCXpresso54114 board to the USB port of your host computer, connecting a micro USB cable to connector J7 ("Link"). The board will run a simple LED blinky example using the tricolor LED, alternating between red and green.
4. Allow about 30 seconds for the LPCXpresso54114 devices to enumerate for the first time. It is not necessary to check the Hardware Manager, however if this is done there will be five devices; four under Human Interface Devices (CMSIS-DAP, LPC-SIO, two HID Compliant Devices, and a USB Input Device) and one under Ports (LPC-LinkII Ucom.)
5. Your board is now ready to use with your 3rd party tool. Follow the instructions for those tools for using a CMSIS-DAP probe.

4. LPC54114 Serial ports

By default the LPC54114 UART0 is connected to the FTDI header at J5. This can be used for ISP booting or sending debug messages out to a host computer via a suitable cable. The LPC54114 UART0 can also be connected through a virtual communication port (VCOM) UART bridge Link2 function to a host computer connected to the J6 USB Link2.

The factory default CMSIS-DAP Link2 image includes UART bridge functionality (VCOM support), and this firmware is also available with the LPCScrypt utility, available at <http://www.nxp.com/lpcutilities>. When running this firmware the default source of data to the LPC54114 RXD is the FTDI header. Once the Link2 receives any data via the VCOM port of a host computer it will set P2_2 low to select the Link2 UART0 data to the LPC54114. In order to reset this so the FTDI connection can be used it is necessary to power cycle the board.

4.1 P3 FTDI header

The FTDI header P3 mates with FTDI cable TTL-232R-3V3. P3 interfaces the LPC54114 UART0 to a Host PC virtual serial port. The location of P3 is shown in Fig 3. The pin out and a description of the signals at P3 are listed in [Table 2](#).

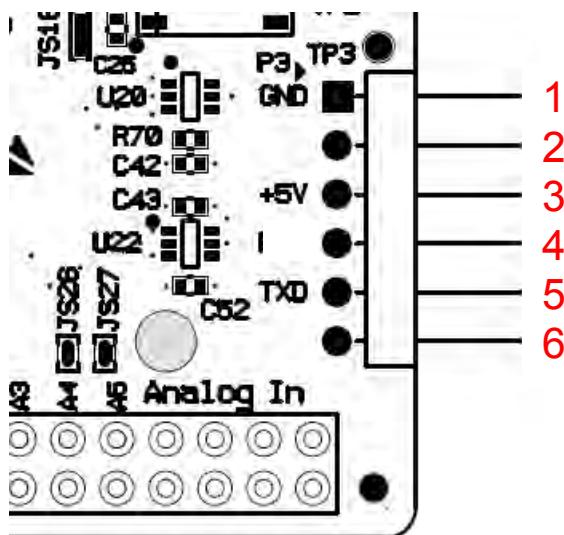


Fig 3. FTDI connector

Table 2. P3 FTDI interface

LPC54114 Signal	FTDI signal	Pin #	Direction	LPC54114 Signal
GND	GND	1		GND
No connect	CTS	2		No connect
Board +5V	5V	3		Board +5V
UART0_RXD	TXD	4	From host	UART0_RXD
UART0_TXD	RXD	5	To host	UART0_TXD
No connect	RTS	6		GND

5. Board power connections and measurement

The LPCXpresso54114 board requires +5V input to power the on-board voltage regulators which in turn power the Link2 debug probe and other +3.3V circuits, the LPC54114 target and other +1.8V circuits, and the Arduino +5V and +3.3V power rails. When the main external power source is from the Link2 side USB micro B-type connector (J7), both the Link side and LPC54114 Target sections of the board are powered. When the main external power is from the Target side USB micro B-type connector (J5), or FTDI header (P3) only the LPC54114 Target section of the board is powered.

A block diagram of the board power tree is shown in [Fig 4](#). When the LPC54114 Target is to be debugged from an external debug probe, instead of the on-board Link2 debug probe, the Link USB connector (J7) must be disconnected. The circle with I indicates where the current monitoring circuitry measures / where an ammeter can be inserted.

The LPC54114 Target VDD selection of 1.8V or 3.3V is made at JP9, with 3.3V set as the default.

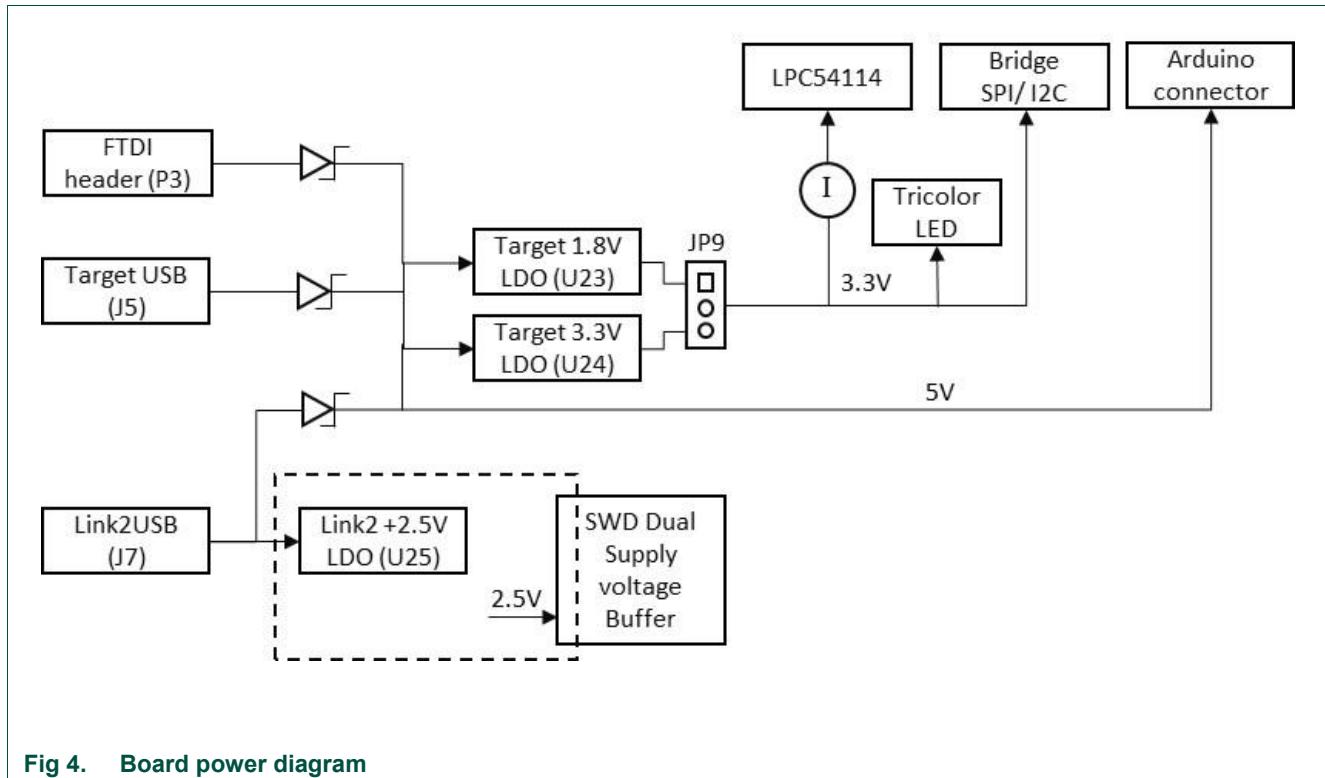


Fig 4. Board power diagram

5.1 LPCXpresso54114 current measurement

The LPC54114 current can be measured by measuring the voltage across a sense resistor in series with the supply, a current meter or using the on board current measurement circuit. Each of these methods will be described in subsections below. There is no current monitoring of the Link2 section circuits on the board. The Target side power going to LEDs and support ICs is not monitored by the current measurement circuit. The LPC54114 LQFP package has the core and IO power both sourced from the same VDD pins.

When a shield board is attached, attempting to measure the lowest possible power the LPC54114 IO pins must be configured according to how the software has configured the shield board to ensure there is no extra current from the LPC54114 IO ports that have external pull-up or pull-down resistors enabled. JS19 should be opened to ensure no leakage through the tri-color LED and +3.3V supply, and JP6 opened to avoid leakage to the Link2 via the I2C and SPI connections between it and the LPC54114.

5.1.1 LPC54114 Vsense resistor current measurement

The voltage across a series 4.12Ω resistor with the target LPC54114 VDD can be manually measured at P2 on the PCB. The voltmeter positive probe is applied to P2 pin 1 (square pad) and negative probe to P2 pin 2. Use Ohm's law to calculate the current (LPC54114 current = measured voltage / 4.12Ω). As an example if the measured voltage is 10mV, then $10e-3 / 4.12\Omega = 2.44mA$. Note that the input current to the MAX9634 used in the on-board current measurement will be included in the voltage measured across this resistor.

5.1.2 LPC54114 VDD current measurement using a current meter

A current meter may be inserted at JP4 to measure the LPC54114 VDD input current. The 0Ω resistor at JS11 must be removed and the current meter connected at the positive input at JP4 pin 1 (square pad) and negative input at pin 2.

5.1.3 LPC54114 VDD current measurement

The LPCXpresso54114 board has an on-board current measurement circuit consisting of a MAX9634T (U5) current monitor chip and a 12-bit ADC (ADC122S021, U11) with a 12-bit sample at 50k to 200ksps. The on-board MAX9634T current monitor measures the voltage across the LPC54114 VDD vsense resistors; either 8.24Ω or 4.12Ω if JP3 is installed. The MAX9634 multiplies the sense voltage by 25 to provide a voltage range suitable for the ADC to measure. A 2-input analog mux selects between the LPC54114 current monitor and the output on a MAX9634T current monitor chip on an expansion board (with compatible current measurement circuit on-board). The current measurement circuit is controlled by the Link2 processor and is not user programmable. Power measurement utilities to use this feature are available in the LPCXpresso IDE installation.

Due to input offset voltage variations in the MAX9634, the current measurement circuit is not recommended for measuring current below 150uA. See [Fig 5](#) as a guideline for measurement error versus measured current.

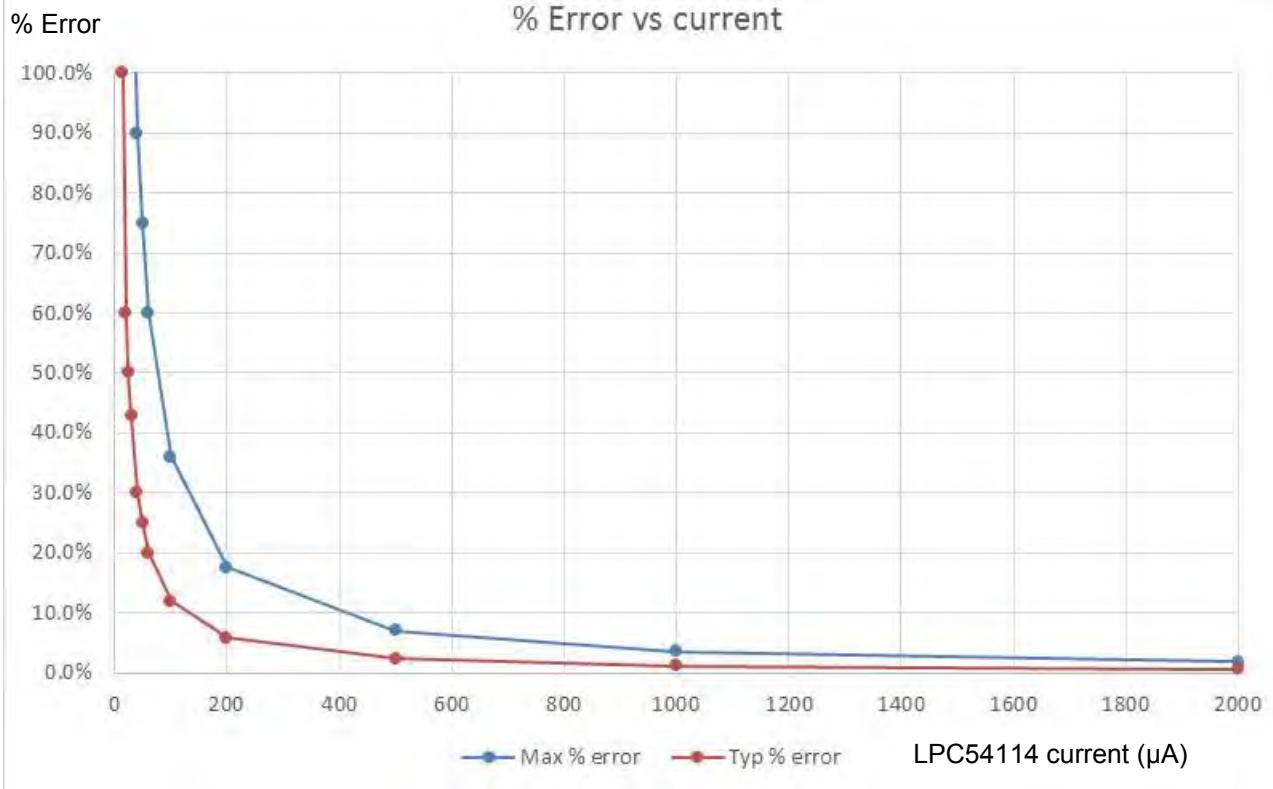


Fig 5. Current measurement circuit error

5.1.4 Shield board current measurement

To use the on-board current measurement circuitry, any expansion board must match the functionality of the LPCXpresso54114. Refer to the board schematics for more information.

6. Debug Configurations

The LPCXpresso54114 LQFP board has a built-in debug probe referred to as “Link2”. The LPC54114 target MCU can be debugged by the Link2 debugging probe, or from an external debug probe installed at P1. On-board jumpers JP1 and JP2 must be correctly positioned for each mode. The on-board Link2 debug probe is capable of debugging target MCU’s with a VDDIO range of 1.6V to 3.6V. Use JP9 to set the LPC54114 chip VDD to the desired voltage level (+1.8V or +3.3V). Check the sections below for the appropriate jumper settings and how to properly power the board.

6.1.1 Debugging LPC54114 target using on-board (Link2) debug probe

To use the on-board Link debug probe, the LPCXpresso54114 board must be powered from the Link2 USB connector J7, and jumper JP2 must be fitted in position pin 1 - 2 (Local Target). Jumper JP1 must be open to enable the target LPC54114. Connecting the micro USB J7 to a host computer will power the Link and Target sections of the board and provide the USB link to the debug tool software.

6.1.2 Debug LPC54114 target using external debug probe

To use an external debug probe, connect the probe to the SWD (P1) connector, power the LPC54114 Target section of the board from the Target micro USB connector J5, and fit a jumper to JP2 across pin 1 - 2 (Local Target). Jumper JP1 must be open to enable the target LPC54114. The on-board Link2 debug probe must be unpowered, by leaving J7 unconnected.

6.1.3 On-board Link2 flash programming

To program the Link2 Flash the Link2 MCU must be in DFU mode. If the Link2 already has a valid image in the flash, you will need to force it into DFU mode by placing a jumper shunt on JP5, then power the board by connecting the micro USB J7 to a host computer. Link2 MCU programming is performed using the LPCScrypt utility (see <http://www.nxp.com/lpcutilities>). Instructions for using the tool are located at the same web page.

6.2 Using on-board Link2 to debug an off-board target LPC MCU

The LPCXpresso54114 board's Link2 debug probe may be used to debug an off-board target MCU. The on-board Link2 debug probe is capable of debugging target MCU's with a VDDIO range of 1.6V to 3.6V. To keep the on-board target LPC54114 MCU from interfering with the SWD interface, JP1 must be fitted. The Link2 debug probe SWD is connected by a ribbon cable between the P1 connector to the off-board target MCU SWD interface. Power the LPCXpresso54114 board from the Link USB connector J7, and fit jumper JP2 across pins 2 - 3 (External Target).

7. LED indicators

The LPCXpresso54114 board LED locations are shown in Fig 2. A description of each on-board LED indicator is shown in [Table 3](#).

Table 3. LED indicator functions

LED reference	Description
D1	Link2 MCU BOOT0_LED indicator. Reflects the state of Link2 MCU P1_1. When the boot process fails, D1 will toggle at a 1 Hz rate for 60 seconds. After 60 seconds, the Link2 MCU is reset. It will be ON when the Link2 MCU is Booting using DFU (See description for JP6).
D2	Tri-color LED – Driven by Target LPC54114 MCU. The red led is driven by P0_29. The green led is driven by P0_30. The blue led is driven by P0_31. LEDs are on when the LPC54114 port is output low. To light any of the tri-color leds, JP6 must have a shunt between pins 1 – 2. By default the 0Ω resistor at JS17 provides the shunt for JP6. To measure the lowest possible current from LPC54114 remove the 0Ω resistor at JS17 (remove +3.3V from led common anode).
D3	Target LPC54114 power LED. This LED is on any time power is applied to the Target LPC54114 MCU. LED will have a brighter intensity when the LPC54114 is powered from +3.3V than when powered by +1.8V.
D4	Target Reset LED. This LED is on anytime the Target RESETn is pulled low.

8. Expansion connectors

The LPCXpresso54114 board includes four expansion connectors plus a PMOD™ compatible connector (J3). The expansion connectors (J1, J2, J8 and J9) incorporate an Arduino Uno revision 3 footprint in their inner rows. Not all connector locations are populated on the expansion connectors since the LPC54114 does not have enough I/O to utilize all of the available connections (additional pin locations are provided for compatibility with future LPCXpresso boards).

Table 4. Expansion connectors

Reference	Description
J1	The odd number pins are compatible with Arduino Uno rev3 Digital 15:8, AREF, SDA & SCL connector. The even numbered pins are used for external access and expansion of LPC54114 signals not used by the Arduino Uno rev3 compatible interface.
J2	The odd numbered pins 1 – 13 are compatible with Arduino Uno rev3 Digital 7:0 connector. The even numbered pins, and odd numbered pins 17 and 19, are used for external access and expansion of LPC54114 signals not used by the Arduino Uno rev3 compatible interface.
J3	PMod™ connector. Connected to the LPC54114 Target MCU SPI0 and I2C2.
J8	The even numbered pins 6 – 20 are compatible with Arduino Uno rev3 Power connector. The odd numbered pins, and even numbered pins 2 and 4 are used.
J9	The even numbered pins 2 – 12 are compatible with Arduino Uno rev3 Analog connector. The odd numbered pins are used for external access and expansion of LPC54114 signals not used by the Arduino Uno rev3 compatible interface.

9. Buttons

The LPCXpresso54114 board has 4 push buttons available to control the operation of the LPC54114 (target) MCU. Their functions are as described below.

9.1 Reset

This button is used to reset the LPC54114 (note that the Link2 is NOT reset by this button.)

9.2 ISP0 and ISP1

These button connect to the LPC54114 P0_31 (ISP0 button) and P0_4 (ISP1 button) pin and may be used to force the LPC54114 into its various ISP boot modes. See [Table 5](#).

Table 5. ISP boot mode control

Boot mode	ISP0	ISP1	Vbus (from J5)
I2C/SPI boot	Pressed	Pressed	X
UART boot	Pressed	Not pressed	0
USB Mass storage	Pressed	Not pressed	1
Boot from internal flash	Not pressed	Not pressed	

To force entry into one of these boot modes hold down the required button(s), press and release the Reset button, then release the ISP button(s).

Note that for USB Mass Storage boot to work, a USB host must be connected to J5 and JP10 must be installed in order to route Vbus to the LPC54114. When the LPC54114 has been booted in mass storage mode a firmware image (which must be named firmware.bin) can be virtually “dragged and dropped” onto the board (which appears as a mass storage device called “CRP DISABLED” on the host computer) using a file manager utility (such as File Explorer on Windows, or Finder on MacOS). Before dropping new firmware onto the board the existing firmware.bin needs to be deleted.

This can be useful when the LPC54114 flash has been programmed with code that disables the SWD debug pins or changes timing settings such that the debug probe has problems communicating with it. The ISP buttons can be used to force the LPC54114 into a state where the debugger can regain debug control.

The ISP buttons can also be used to trigger an interrupt by configuring the P0_31 / P0_4 pins and associated interrupt controls within your application code.

9.3 WAKE

This button can be used to generate an interrupt by pulling down the P0_24 of the LPC54114.

10. Legal information

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